



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



Xinger®

Micro Xinger 10dB Directional Coupler



Description

The 1M810 Micro Xinger® is a low profile, miniature 10dB directional coupler in an easy to use surface mount package designed for U-NII, ISM and hyperLAN applications. The 1M810 is for power and frequency detection as well as power injection and is an ideal solution for the ever-increasing demands of the wireless industry for smaller printed circuit boards and high performance. Parts have been subjected to rigorous qualification testing and units are 100% tested. They are manufactured using materials with x and y thermal expansion coefficients compatible with common substrates such as FR4, G-10 and polyamide. Available in 6 of 6 RoHS compliant tin immersion (1M810S).

Features:

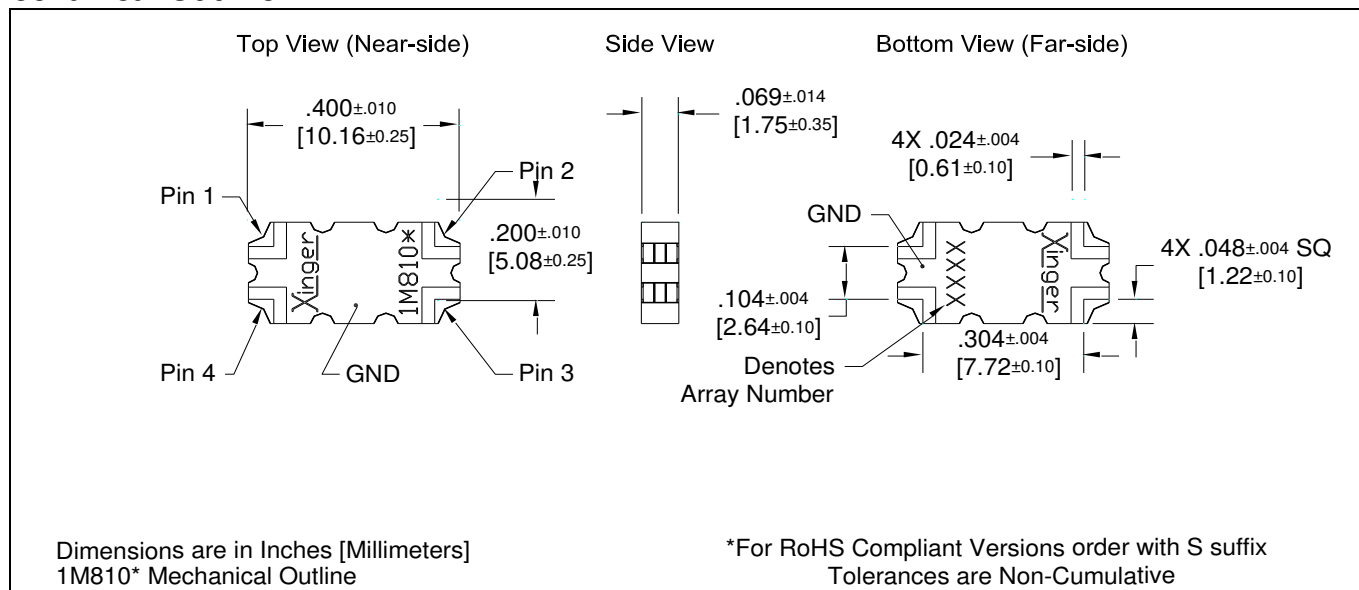
- 5.0 – 6.0 GHz
- Very Low Loss
- High Directivity
- Surface Mountable
- Tape And Reel
- Available in Lead-Free finish

ELECTRICAL SPECIFICATIONS**

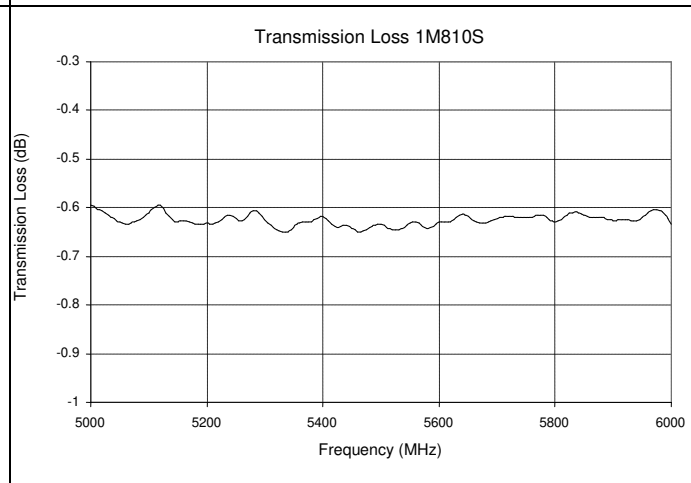
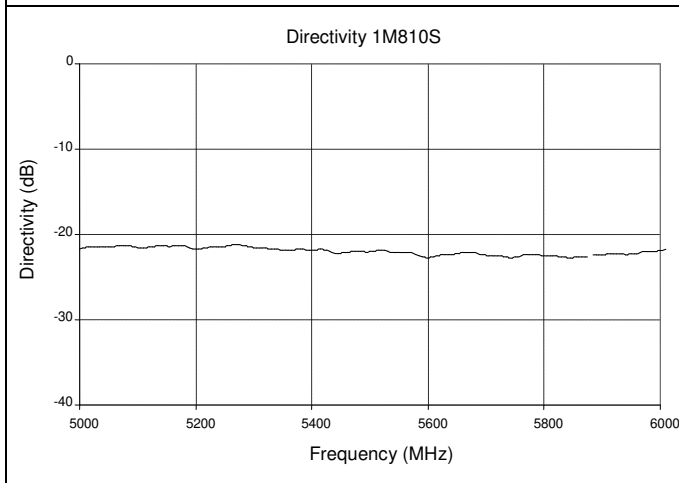
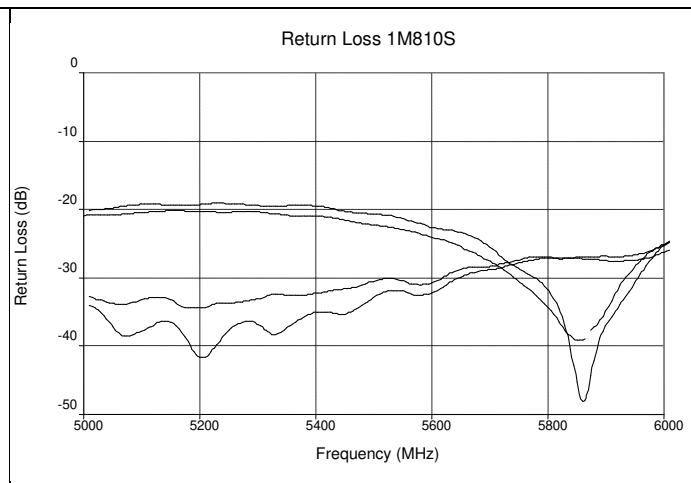
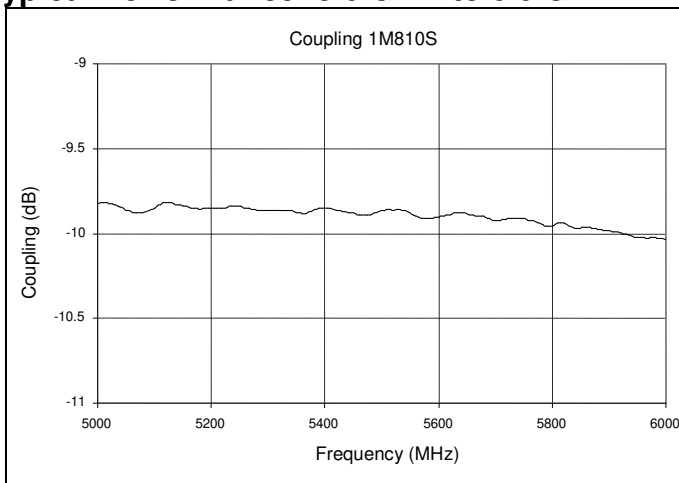
Frequency	Mean Coupling	Insertion Loss	VSWR	Freq. Sensitivity
GHz	dB	dB Max	Max : 1	dB Max
5.0 – 6.0	10.0 ± .75	0.30	1.33	± .30
Directivity	Power Handling	ΘJC	Operating Temp.	
dB Min	Watts	°C / Watt	°C	
18	15	23.8	-55 to +85	

**Specification based on performance of unit properly installed on microstrip printed circuit boards with 50 Ω nominal impedance. Specifications subject to change without notice.

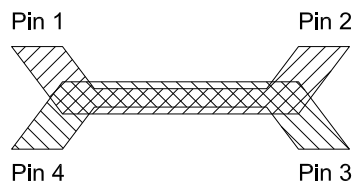
Mechanical Outline



Typical Performance: 5.0 GHz. to 6.0 GHz.



Pin Configuration

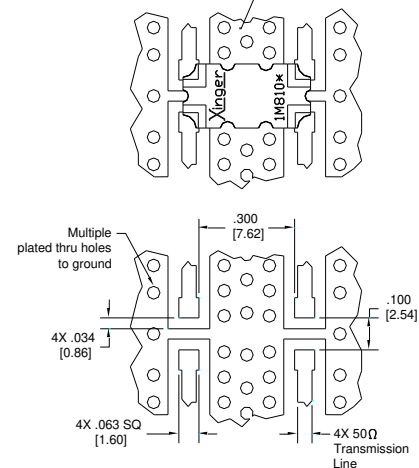


Directional Coupler Pin Configuration

	Pin 1	Pin 2	Pin 3	Pin 4
Configuration #1	Input	Output	Isolated	Coupled
Configuration #2	Output	Input	Coupled	Isolated
Configuration #3	Isolated	Coupled	Input	Output
Configuration #4	Coupled	Isolated	Output	Input

Mounting Footprint

To ensure proper electrical and thermal performance there must be a ground plane with 100% solder connection underneath the part



Dimensions are in Inches [Millimeters]
1M810 Mounting Footprint

USA/Canada: (315) 432-8909
Toll Free: (800) 544-2414
Europe: +44 2392-232392

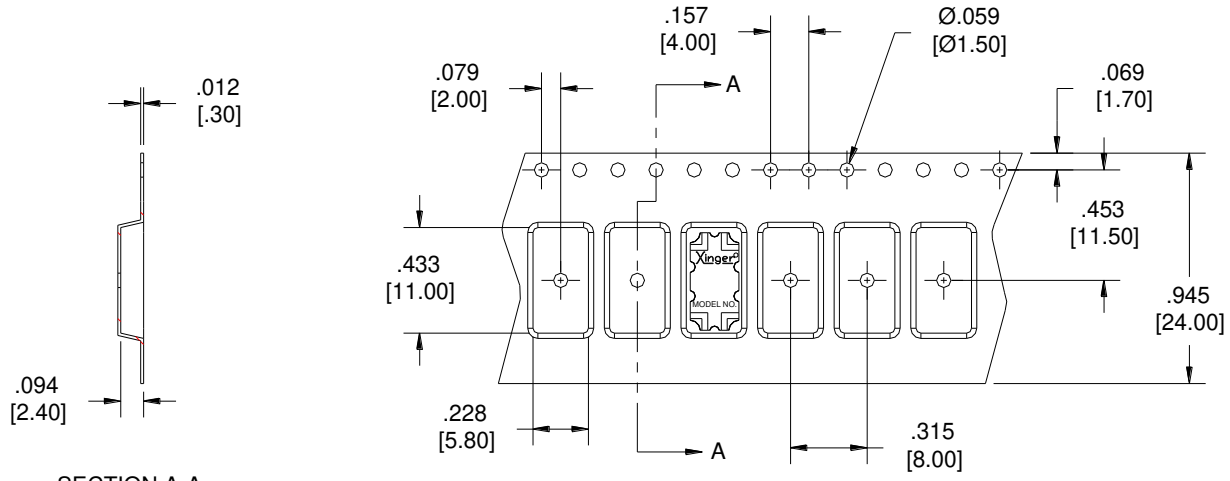
Available on Tape and Reel For Pick and Place Manufacturing.





PACKAGING

Packaging follows EIA-481-2. Parts are oriented in tape as shown below. Minimum order quantities are 2000 per reel.



Tape and Reel Diagram

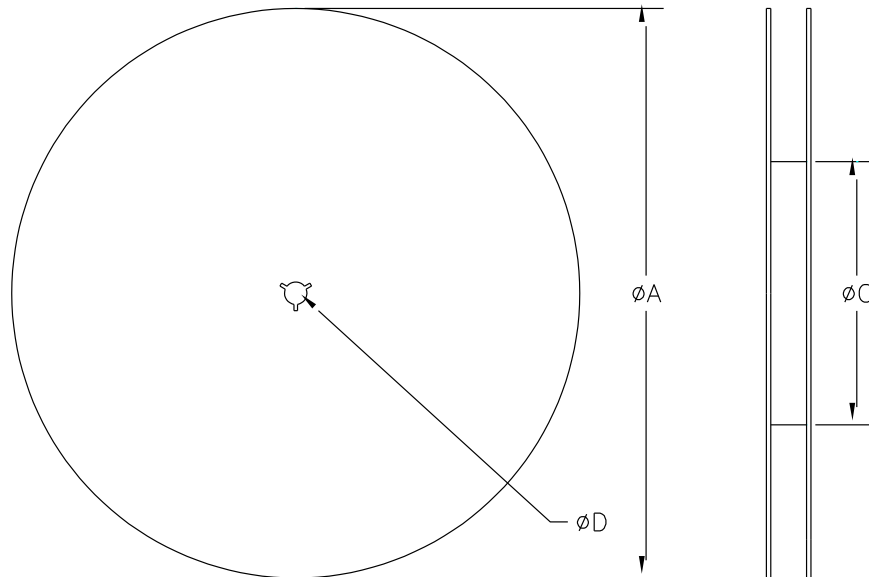


TABLE 1	
REEL DIMENSIONS (inches [mm])	
ϕA	13.3 [333.0]
B	0.945 [24.0]
ϕC	4.017 [102.03]
ϕD	0.512 [13.0]

